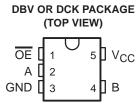
- 5-Ω Switch Connection Between Two Ports
- TTL-Compatible Control Input Levels
- Package Options Include Plastic Small-Outline Transistor (DBV, DCK) Packages



### description

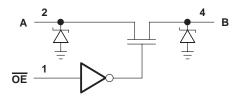
The SN74CBTS1G125 features a single high-speed line switch with Schottky diodes on the I/O to clamp undershoot. The switch is disabled when the output-enable  $(\overline{OE})$  input is high.

The SN74CBTS1G125 is characterized for operation from -40°C to 85°C.

### **FUNCTION TABLE**

INPUT OE	FUNCTION		
L	A port = B port		
Н	Disconnect		

# logic diagram (positive logic)





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# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage range, V <sub>CC</sub>	0.5 V to 7 V
Input voltage range, V <sub>I</sub> (see Note 1)	0.5 V to 7 V
Continuous channel current	128 mA
Input clamp current, I <sub>IK</sub> (V <sub>I/O</sub> < 0)	–50 mA
Package thermal impedance, θ <sub>JA</sub> (see Note 2): DBV package	206°C/W
DCK package	252°C/W
Storage temperature range, T <sub>sto</sub>	65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### recommended operating conditions (see Note 3)

		MIN	MAX	UNIT
VCC	Supply voltage	4	5.5	V
VIH	High-level control input voltage	2		V
VIL	Low-level control input voltage		0.8	V
TA	Operating free-air temperature	-40	85	°C

All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER TEST CONDITIONS		MIN	TYP‡	MAX	UNIT				
VIK		$V_{CC} = 4.5 \text{ V},$	I <sub>I</sub> = -18 mA					-0.7	V
I IIL V FFV		V <sub>I</sub> = GND					-1	μΑ	
†ı	lН	V <sub>CC</sub> = 5.5 V	V <sub>I</sub> = 5.5 V					50	μΑ
ICC		$V_{CC} = 5.5 \text{ V},$	$I_{O} = 0$ ,	$V_I = V_{CC}$ or G	ND			3	μΑ
Ci	Control input	$V_I = 3 V \text{ or } 0$							pF
C <sub>io(OF</sub>	F)	$V_0 = 3 \text{ V or } 0,$	OE = V <sub>CC</sub>						pF
r <sub>on</sub> §		$V_{CC} = 4 V$ ,	TYP at $V_{CC} = 4 V$ ,	$V_1 = 2.4 V$ ,	I <sub>I</sub> = 15 mA				
		V <sub>CC</sub> = 4.5 V	V <sub>I</sub> = 0	I <sub>I</sub> = 64 mA					Ω
				I <sub>I</sub> = 30 mA					52
			V <sub>I</sub> = 2.4 V,	I <sub>I</sub> = 15 mA					

<sup>‡</sup> All typical values are at  $V_{CC} = 5 \text{ V}$  (unless otherwise noted),  $T_A = 25^{\circ}\text{C}$ .



NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

<sup>2.</sup> The package thermal impedance is calculated in accordance with JESD 51.

<sup>§</sup> Measured by the voltage drop between the A and the B terminals at the indicated current through the switch. On-state resistance is determined by the lower of the voltages of the two (A or B) terminals.

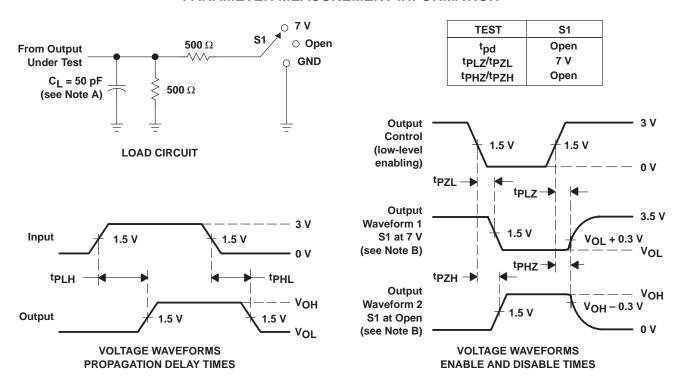
# RODUCT PREVIEW

# switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> = 4 V		V <sub>CC</sub> = 5 V ± 0.5 V		UNIT
			MIN	MAX	MIN	MAX	
t <sub>pd</sub> †	A or B	B or A					ns
t <sub>en</sub>	ŌĒ	A or B					ns
<sup>t</sup> dis	ŌĒ	A or B					ns

<sup>†</sup> The propagation delay is the calculated RC time constant of the typical on-state resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).

### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_0 = 50 \Omega$ ,  $t_f \leq$  2.5 ns,  $t_f \leq$  2.5 ns.
- D. The output is measured with one input transition per measurement.
- E. tpLZ and tpHZ are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tplH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms



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